

# SANYO Semiconductors DATA SHEET

N-Channel Silicon MOSFET

# **BFL4001** — General-Purpose Switching Device Applications

#### **Features**

- · Low ON-resistance.
- · High-speed switching.
- · Avalanche resistance guarantee.
- · 10V drive.

## **Specifications**

#### Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V <sub>DSS</sub>		900	V
Gate-to-Source Voltage	VGSS		±30	V
Drain Current (DC)	I <sub>Dc</sub> *1	Limited only by maximum temperature Tch=150°C	6.5	Α
	I <sub>Dpack*2</sub>	Tc=25°C (SANYO's ideal heat dissipation condition)*3	4.1	Α
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	13	Α
Allowable Power Dissipation	D-		2.0	W
	PD	Tc=25°C (SANYO's ideal heat dissipation condition*)3	37	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C
Avalanche Energy (Single Pulse) *4	EAS		237	mJ
Avalanche Current *5	lav		6.5	Α

Note:\*1 Shows chip capability

The method is applying silicone grease to the backside of the device and attaching the device to water-cooled radiator made of aluminium.

Marking: FL4001

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<sup>\*2</sup> Package limited

<sup>\*3</sup> SANYO's condition is radiation from backside.

<sup>\*4</sup> VDD=99V, L=10mH, IAV=6.5A

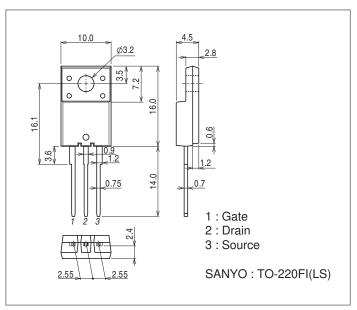
<sup>\*5</sup> L≤10mH, single pulse

#### **Electrical Characteristics** at Ta=25°C

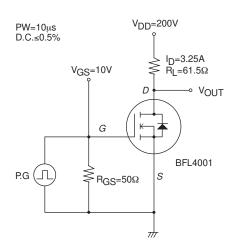
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=10mA, VGS=0V	900			V
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =720V, V <sub>GS</sub> =0V			1.0	mA
Gate-to-Source Leakage Current	IGSS	V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V			±100	nA
Cutoff Voltage	V <sub>GS</sub> (off)	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA	2.0		4.0	V
Forward Transfer Admittance	yfs	V <sub>DS</sub> =20V, I <sub>D</sub> =3.25A	1.8	3.6		S
Static Drain-to-Source On-State Resistance	R <sub>DS</sub> (on)	I <sub>D</sub> =3.25A, V <sub>GS</sub> =10V		2.1	2.7	Ω
Input Capacitance	Ciss	V <sub>DS</sub> =30V, f=1MHz		850		pF
Output Capacitance	Coss	V <sub>DS</sub> =30V, f=1MHz		130		pF
Reverse Transfer Capacitance	Crss	VDS=30V, f=1MHz		43		pF
Turn-ON Delay Time	t <sub>d</sub> (on)	See specified Test Circuit.		19		ns
Rise Time	t <sub>r</sub>	See specified Test Circuit.		49		ns
Turn-OFF Delay Time	t <sub>d</sub> (off)	See specified Test Circuit.		156		ns
Fall Time	tf	See specified Test Circuit.		52		ns
Total Gate Charge	Qg	V <sub>DS</sub> =200V, V <sub>GS</sub> =10V, I <sub>D</sub> =6.5A		44		nC
Gate-to-Source Charge	Qgs	V <sub>DS</sub> =200V, V <sub>GS</sub> =10V, I <sub>D</sub> =6.5A		7.0		nC
Gate-to-Drain "Miller" Charge	Qgd	V <sub>DS</sub> =200V, V <sub>GS</sub> =10V, I <sub>D</sub> =6.5A		22		nC
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =6.5A, V <sub>GS</sub> =0V		0.85	1.2	V

# **Package Dimensions**

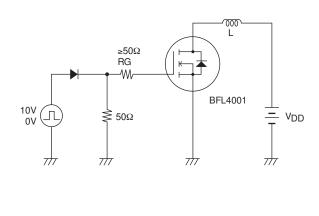
unit : mm (typ) 7509-002

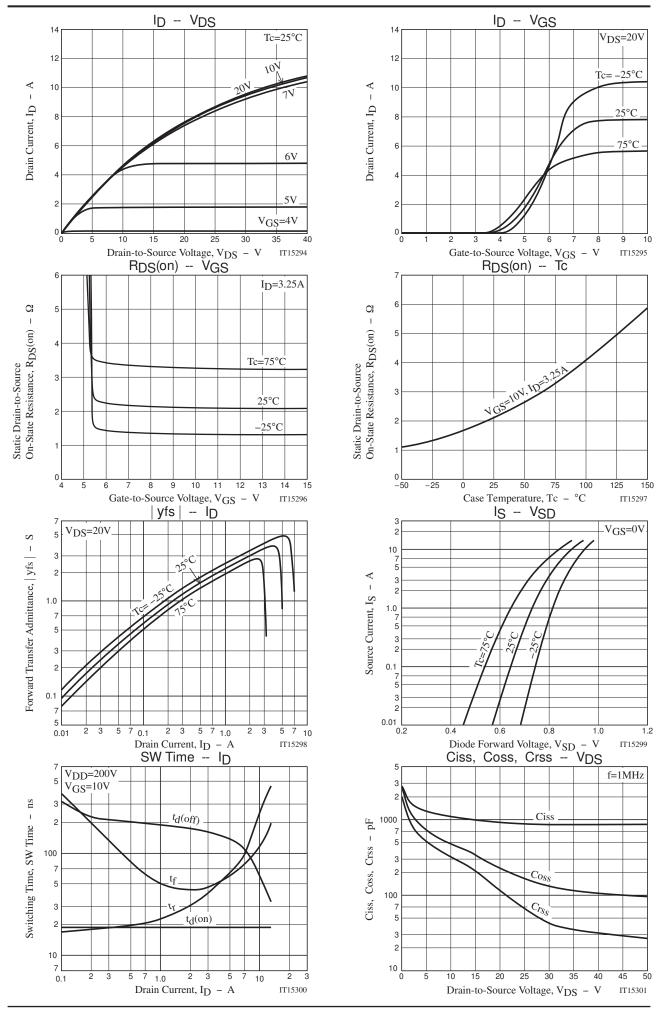


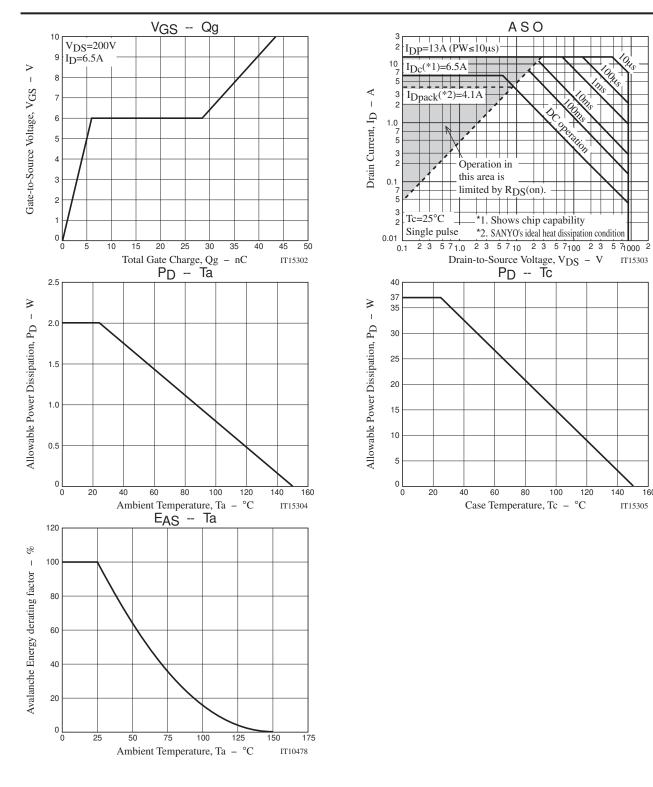
# **Switching Time Test Circuit**



### **Avalanche Resistance Test Circuit**







140

160

IT15305

Note on usage: Since the BFL4001 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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